

**DISCRIPTION**

2SC3240 is a silicon NPN epitaxial planar type transistor specifically designed for high power amplifiers in HF band.

**FEATURES**

- High gain:  $G_{pe} \geq 11.5\text{dB}$ ,  $P_o \geq 100\text{W}$   
@f = 30MHz,  $V_{CC} = 12.5\text{V}$ ,  $P_{in} = 7\text{W}$
- High ruggedness: Ability to withstand 20:1 load VSWR when operated at f = 30MHz,  $P_o = 100\text{W}$ ,  $V_{CC} = 15.2\text{V}$ .
- Emitter ballasted construction
- Low thermal resistance ceramic package with flange.

Input-output impedance

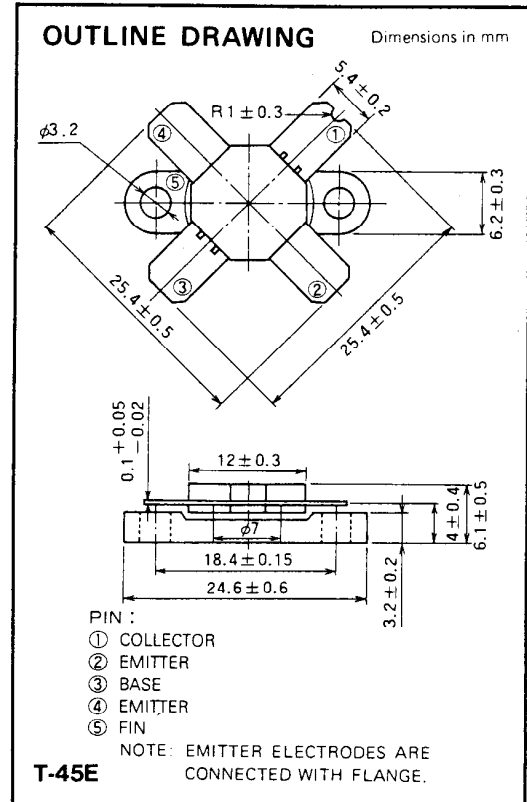
$Z_{in} = 0.4 - j0.8 (\Omega)$

$Z_{out} = 1.0 - j1.1 (\Omega)$

@f = 30MHz,  $V_{CC} = 12.5\text{V}$ ,  $P_o = 100\text{W}$

**APPLICATION**

Output stage of transmitter in HF band SSB mobile radio sets.



**ABSOLUTE MAXIMUM RATINGS** ( $T_C = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Unit
$V_{CBO}$	Collector to base voltage		50	V
$V_{EBO}$	Emitter to base voltage		5	V
$V_{CEO}$	Collector to emitter voltage	$R_{BE} = \infty$	20	V
$I_C$	Collector current		25	A
$P_C$	Collector dissipation	$T_a = 25^\circ\text{C}$	8	W
		$T_C = 25^\circ\text{C}$	270	W
$T_j$	Junction temperature		175	$^\circ\text{C}$
$T_{stg}$	Storage temperature		-55 to 175	$^\circ\text{C}$
$R_{th-a}$	Thermal resistance	Junction to ambient	18.7	$^\circ\text{C/W}$
$R_{th-c}$		Junction to case	0.556	$^\circ\text{C/W}$

Note. Above parameters are guaranteed independently.

**ELECTRICAL CHARACTERISTICS** ( $T_C = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$V_{(BR)EBO}$	Emitter to base breakdown voltage	$I_E = 20\text{mA}$ , $I_C = 0$	5			V
$V_{(BR)CBO}$	Collector to base breakdown voltage	$I_C = 20\text{mA}$ , $I_E = 0$	50			V
$V_{(BR)CEO}$	Collector to emitter breakdown voltage	$I_C = 100\text{mA}$ , $R_{BE} = \infty$	20			V
$I_{CBO}$	Collector cutoff current	$V_{CB} = 15\text{V}$ , $I_E = 0$			5	mA
$I_{EBO}$	Emitter cutoff current	$V_{EB} = 3\text{V}$ , $I_C = 0$			5	mA
$h_{FE}$	DC forward current gain *	$V_{CE} = 10\text{V}$ , $I_C = 1\text{A}$	10	50	180	—
$P_o$	Output power	$f = 30\text{MHz}$ , $V_{CC} = 12.5\text{V}$ , $P_{in} = 7\text{W}$	100	110		W
$\eta_C$	Collector efficiency		55	60		%

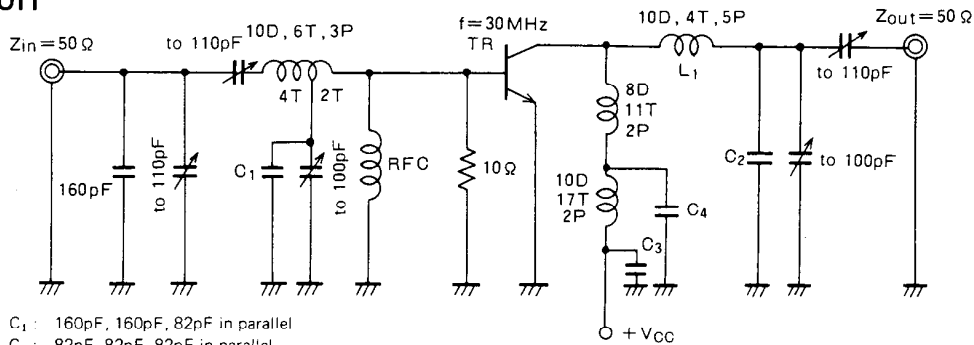
Note. \* Pulse test,  $P_W = 150\mu\text{s}$ , duty = 5%.

Above parameters, ratings, limits and conditions are subject to change.

# MITSUBISHI RF POWER TRANSISTOR 2SC3240

## NPN EPITAXIAL PLANAR TYPE

### TEST CIRCUIT

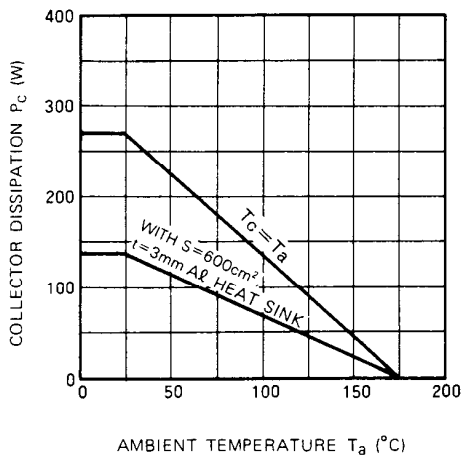


- $C_1$ : 160pF, 160pF, 82pF in parallel  
 $C_2$ : 82pF, 82pF, 82pF in parallel  
 $C_3$ : 100pF, 4700pF, 4700pF, 0.22μF, 0.22μF, 33μF, 330μF in parallel  
 $C_4$ : 100pF, 220pF, 4700pF, 0.1μF, 330μF in parallel  
 RFC: 27 Turns 1φ enameled wire

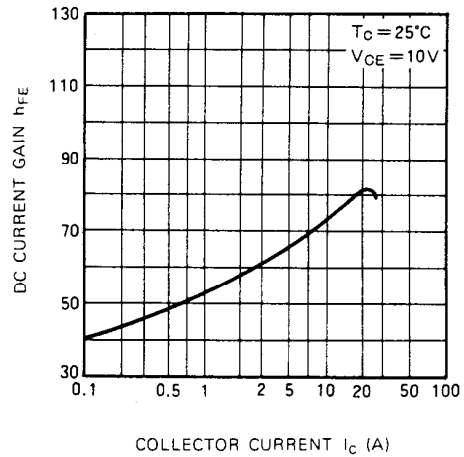
NOTES: All coils but  $L_1$  are made from 1.5φmm silver plated copper wire,  $L_1$  is made from 2.3φmm copper wire.  
 D: Inner diameter of coil  
 T: Turn number of coil  
 P: Pitch of coil  
 Dimension in milli-meter

### TYPICAL PERFORMANCE DATE

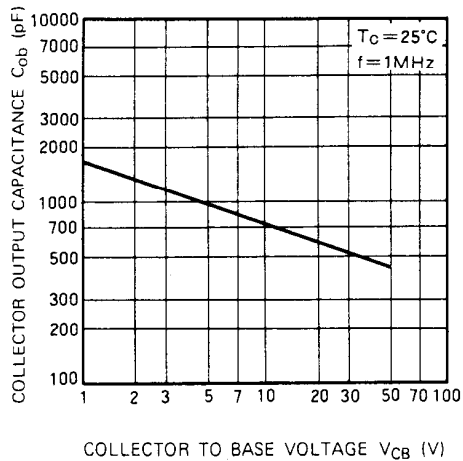
COLLECTOR DISSIPATION VS. AMBIENT TEMPERATURE



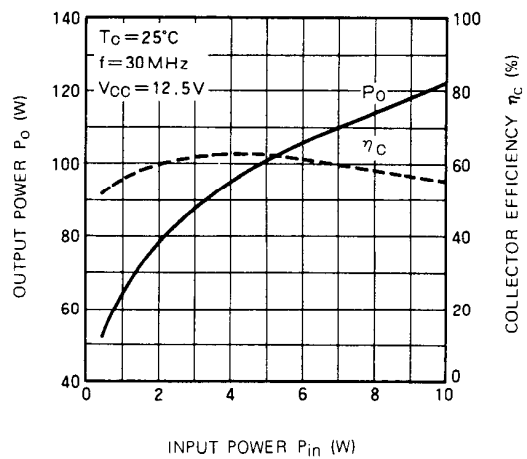
DC CURRENT GAIN VS. COLLECTOR CURRENT



COLLECTOR OUTPUT CAPACITANCE VS. COLLECTOR TO BASE VOLTAGE



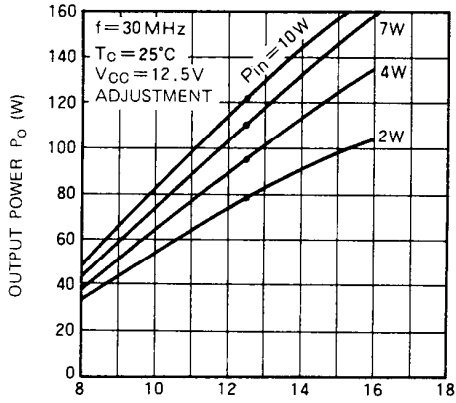
OUTPUT POWER, COLLECTOR EFFICIENCY VS. INPUT POWER



NOV. '97

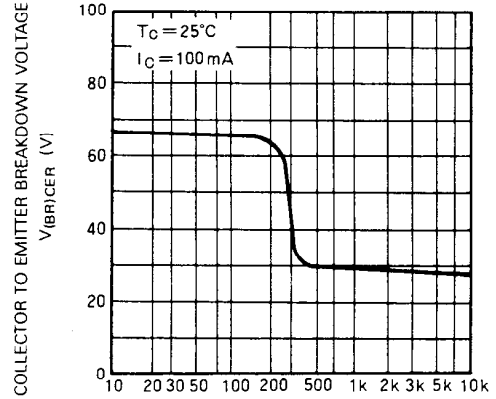
**NPN EPITAXIAL PLANAR TYPE**

**OUTPUT POWER VS. COLLECTOR SUPPLY VOLTAGE**



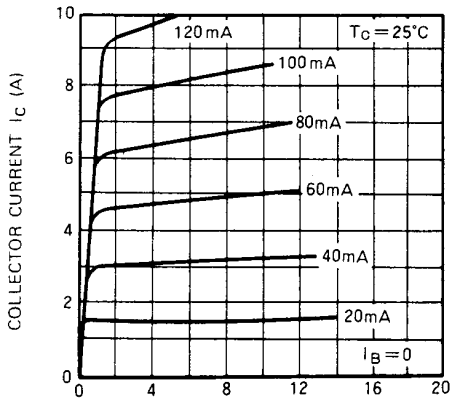
COLLECTOR SUPPLY VOLTAGE  $V_{cc}$  (V)

**COLLECTOR TO EMITTER BREAKDOWN VOLTAGE VS. BASE TO EMITTER RESISTANCE**



BASE TO EMITTER RESISTANCE  $R_{BE}$  ( $\Omega$ )

**COLLECTOR CURRENT VS. COLLECTOR TO EMITTER VOLTAGE**



COLLECTOR TO EMITTER VOLTAGE (V)